

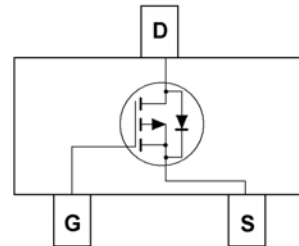
## P-Channel Enhancement Mode MOSFET

### Feature

- -30V/-4.1A,  $R_{DS(ON)} = 80\text{m}\Omega(\text{MAX}) @ V_{GS} = -10\text{V}$ .  
 $R_{DS(ON)} = 100\text{m}\Omega(\text{MAX}) @ V_{GS} = -4.5\text{V}$ .
- Super High dense cell design for extremely low  $R_{DS(ON)}$
- Reliable and Rugged
- SC-59 for Surface Mount Package



SC-59



### Applications

- Power Management  
Portable Equipment and Battery Powered Systems.

### Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ Unless Otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	-4.1	A

### Electrical Characteristics $T_A = 25^\circ\text{C}$ Unless Otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ.	Max	Units
<b>Off Characteristics</b>						
Drain to Source Breakdown Voltage	BVDSS	$V_{GS} = 0\text{V}, I_D = -250\mu\text{A}$	-30	-	-	V
Zero-Gate Voltage Drain Current	IDSS	$V_{DS} = -30\text{V}, V_{GS} = 0\text{V}$	-	-	-1	$\mu\text{A}$
Gate Body Leakage Current, Forward	IGSSF	$V_{GS} = 20\text{V}, V_{DS} = 0\text{V}$	-	-	100	nA
Gate Body Leakage Current, Reverse	IGSSR	$V_{GS} = -20\text{V}, V_{DS} = 0\text{V}$	-	-	-100	nA
<b>On Characteristics</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$	-1.0	-	-3.0	V
Static Drain-source On-Resistance	RDS(ON)	$V_{GS} = -10\text{V}, I_D = -4.1\text{A}$	-	65	80	$\text{m}\Omega$
		$V_{GS} = -4.5\text{V}, I_D = -4.0\text{A}$	-	85	100	$\text{m}\Omega$
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Voltage	VSD	$V_{GS} = 0\text{V}, I_S = -1.0\text{A}$			-1.2	V

## Typical Characteristics

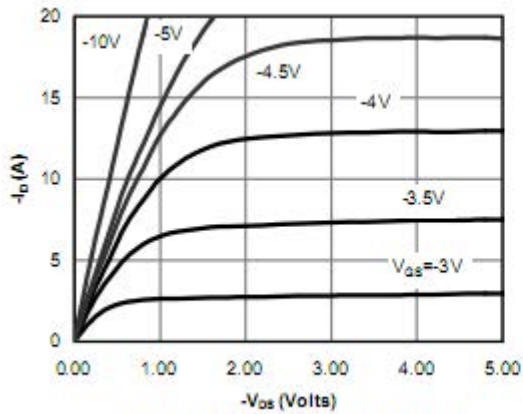


Figure 1: On-Region Characteristics

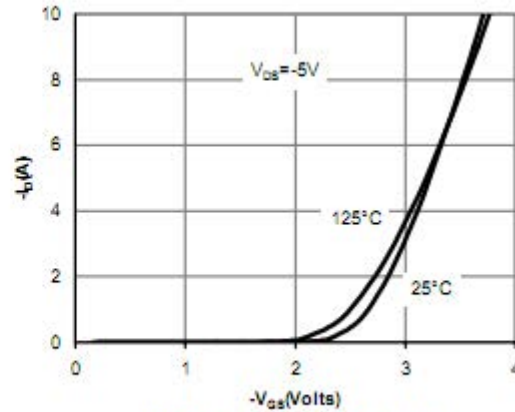


Figure 2: Transfer Characteristics

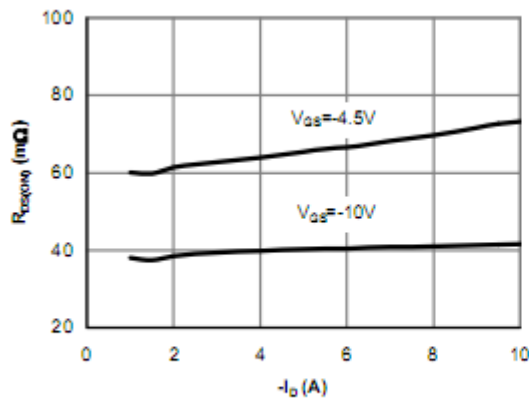


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

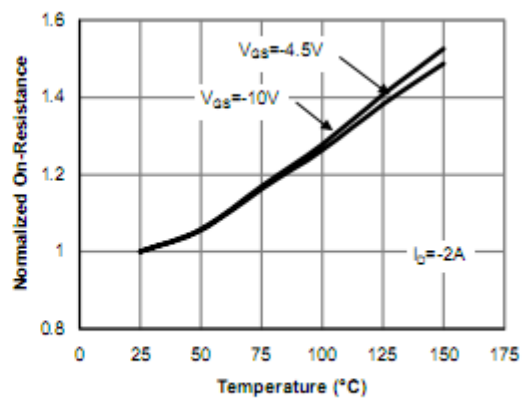


Figure 4: On-Resistance vs. Junction Temperature

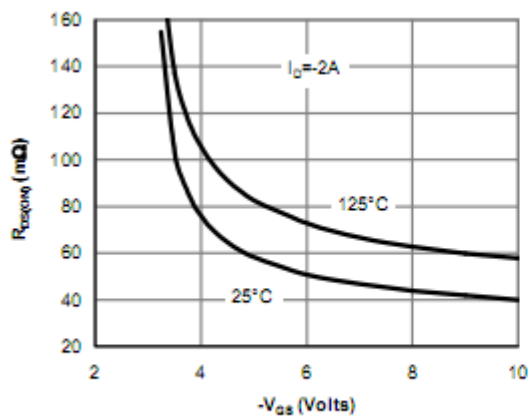


Figure 5: On-Resistance vs. Gate-Source Voltage

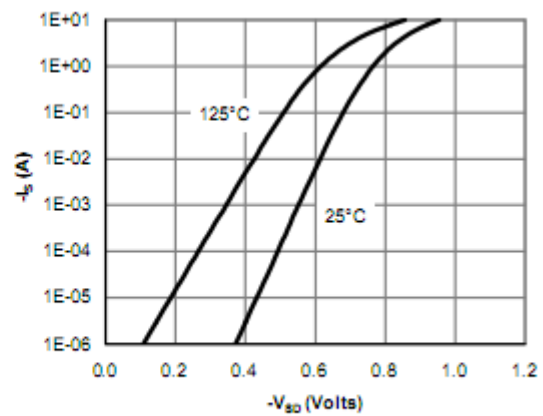


Figure 6: Body-Diode Characteristics

Typical Characteristics

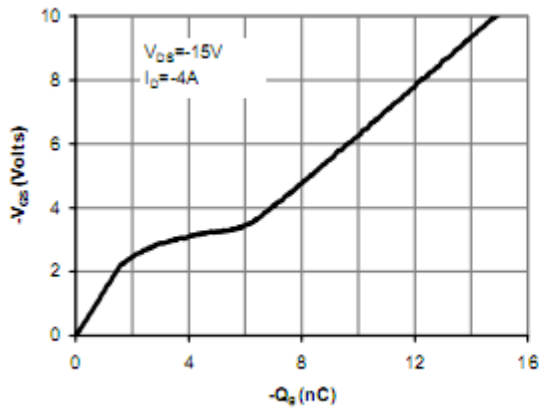


Figure 7: Gate-Charge Characteristics

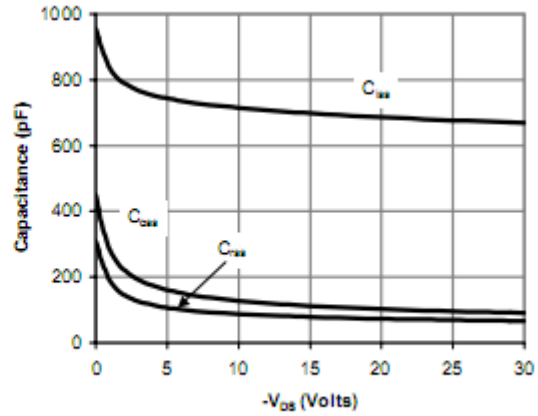


Figure 8: Capacitance Characteristics

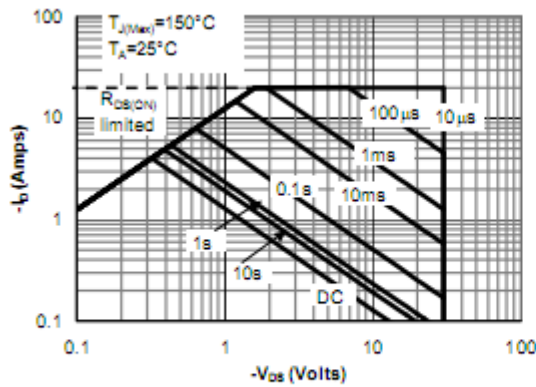


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

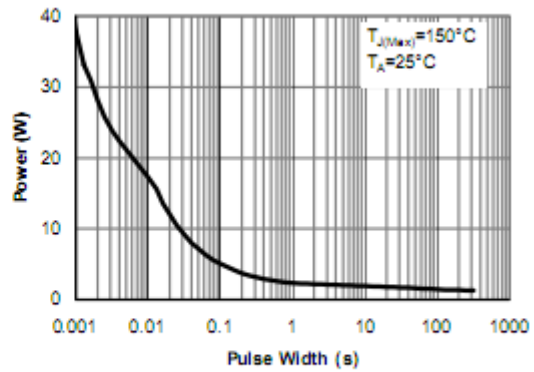


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

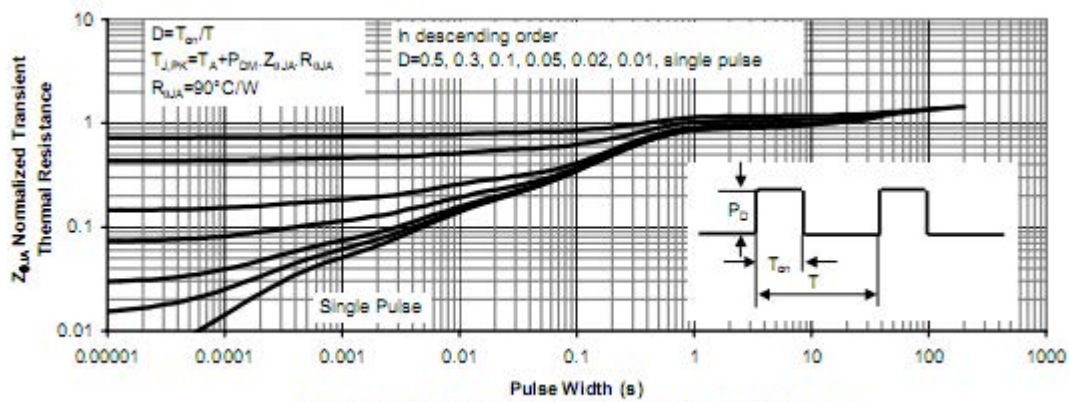


Figure 11: Normalized Maximum Transient Thermal Impedance

## Package Outline Dimensions (UNIT: mm)

SC-59

